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DMN2028USS

20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(on) \max}$	$I_D \max$ $T_A = +25^\circ C$ (Note 6)
20V	20mΩ @ $V_{GS} = 4.5V$	9.8A
	28mΩ @ $V_{GS} = 2.5V$	8.3A

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Output Leakage
- **ESD Protected Up to 2kV**
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

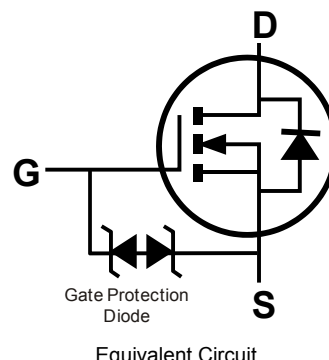
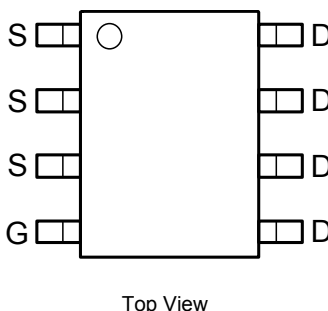
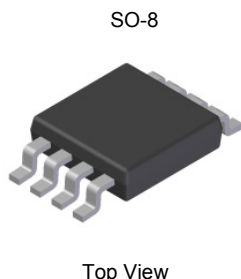
Description and Applications

This MOSFET has been designed to minimize the on-state resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Battery charging
- Power management functions
- DC-DC converters
- Portable power adaptors

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (approximate)

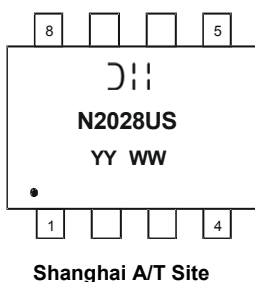
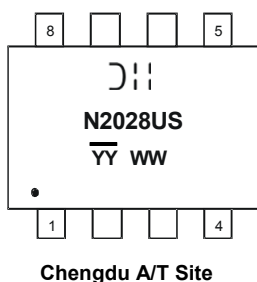


Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN2028USS-13	N2028US	13	12	2,500

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



⌋⌋ = Manufacturer's Marking
 N2028US = Product Type Marking Code
 YYWW = Date Code Marking
 YY or YY = Year (ex: 13 = 2013)
 WW = Week (01 - 53)
 YY = Date Code Marking for SAT (Shanghai Assembly/ Test site)
 YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



DMN2028USS

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

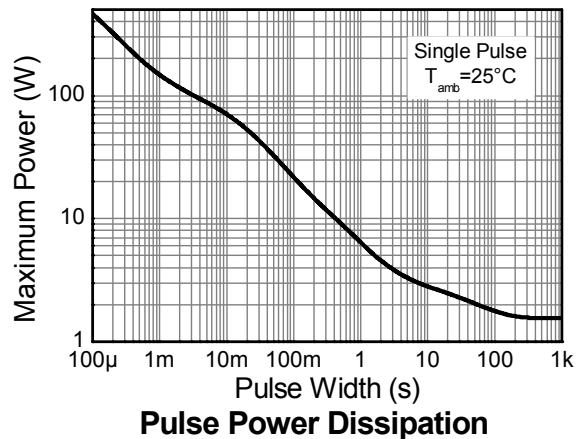
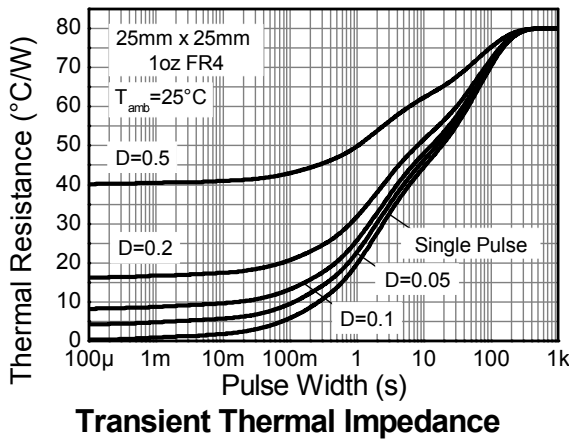
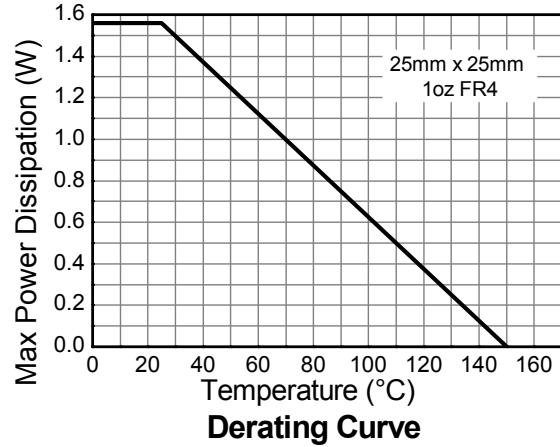
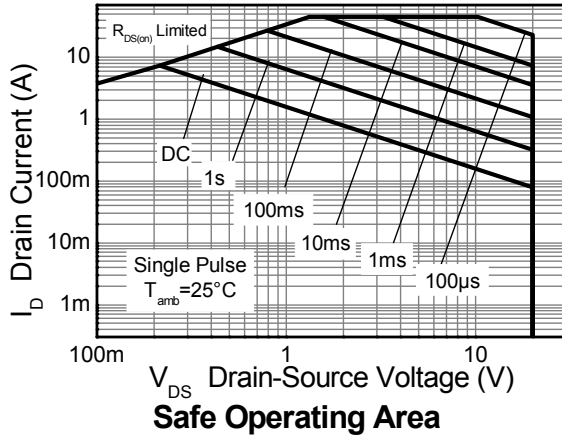
Characteristic			Symbol	Value	Unit
Drain-Source voltage			V _{DSS}	20	V
Gate-Source voltage			V _{GS}	±12	
Continuous Drain current	V _{GS} = 4.5V	(Note 6)	I _D	9.8	A
		T _A = +70°C (Note 6)		7.9	
		(Note 5)		7.3	
Pulsed Drain current	V _{GS} = 4.5V	(Note 7)	I _{DM}	45.0	
Continuous Source current (Body diode)			(Note 6)	I _S	
Pulsed Source current (Body diode)			(Note 7)	I _{SM}	45.0

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Power dissipation	(Note 5)	P _D	1.56	W	
			12.5		
Linear derating factor	(Note 6)		2.81		mW/°C
			22.5		
Thermal Resistance, Junction to Ambient	(Note 5)	R _{θJA}	80.0	°C/W	
	(Note 6)		44.5		
Thermal Resistance, Junction to Lead	(Note 8)	R _{θJL}	37.0		
Operating and storage temperature range		T _J , T _{STG}	-55 to +150		°C

- Notes:
5. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 6. Same as note (5), except the device is measured at t ≤ 10 sec.
 7. Same as note (5), except the device is pulsed with D = 0.02 and pulse width 300µs.
 8. Thermal resistance from junction to solder-point (at the end of the drain lead).

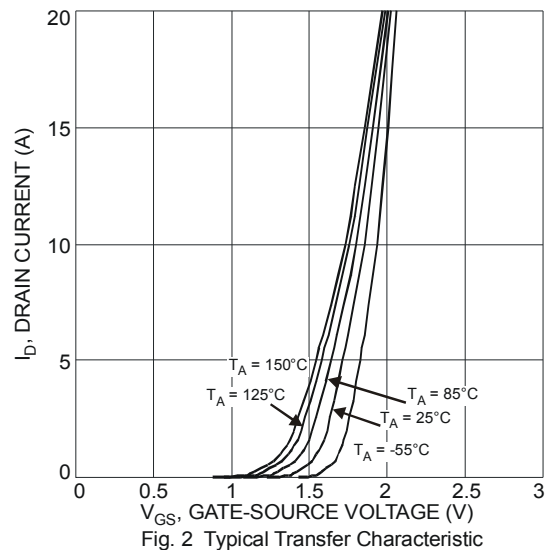
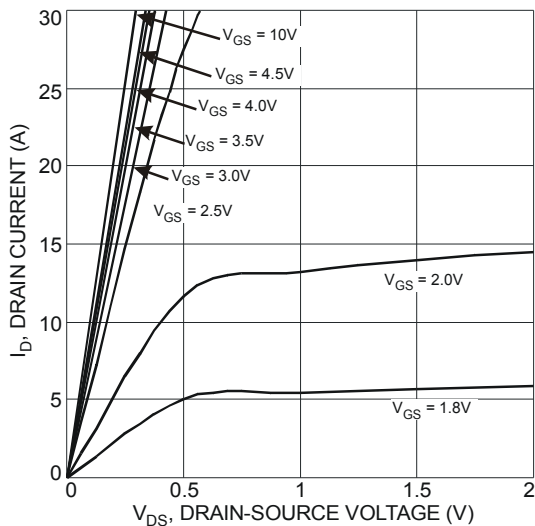
Thermal Characteristics



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	V _{GS} = 0V, I _D = 250μA	
Zero Gate Voltage Drain Current	I _{DSS}	-	-	1.0	μA	V _{DS} = 20V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	-	-	±10	μA	V _{GS} = ±12V, V _{DS} = 0V	
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(th)}	0.6	1.0	1.3	V	V _{DS} = V _{GS} , I _D = 250μA	
Static Drain-Source On-Resistance (Note 9)	R _{DS(on)}	-	11	20	mΩ	V _{GS} = 4.5V, I _D = 9.4A	
			15	28		V _{GS} = 2.5V, I _D = 8.3A	
Forward Transfer Admittance (Note 9 & 10)	Y _{fs}	-	16	-	S	V _{DS} = 5V, I _D = 9.4A	
Diode Forward Voltage (Note 9)	V _{SD}	-	0.7	1.3	V	V _{GS} = 0V, I _S = 1.3A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C _{iss}	-	1000	-	pF	V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	C _{oss}	-	166	-			
Reverse Transfer Capacitance	C _{rss}	-	158	-			
Gate Resistance	R _g	-	1.51	-	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz	
Total Gate Charge (Note 11)	Q _g	-	7.0	-	nC	V _{DS} = 10V I _D = 9.4A	
Total Gate Charge (Note 11)	Q _g	-	11.6	-			V _{GS} = 2.5V
Gate-Source Charge (Note 11)	Q _{gs}	-	2.7	-			V _{GS} = 4.5V
Gate-Drain Charge (Note 11)	Q _{gd}	-	3.4	-			
Turn-On Delay Time (Note 11)	t _{D(on)}	-	11.67	-	ns	V _{GS} = 4.5V, V _{DS} = 10V, R _G = 6Ω, I _D = 1A	
Turn-On Rise Time (Note 11)	t _r	-	12.49	-			
Turn-Off Delay Time (Note 11)	t _{D(off)}	-	35.89	-			
Turn-Off Fall Time (Note 11)	t _f	-	12.33	-			

- Notes: 9. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%
 10. For design aid only, not subject to production testing.
 11. Switching characteristics are independent of operating junction temperatures.





DMN2028USS

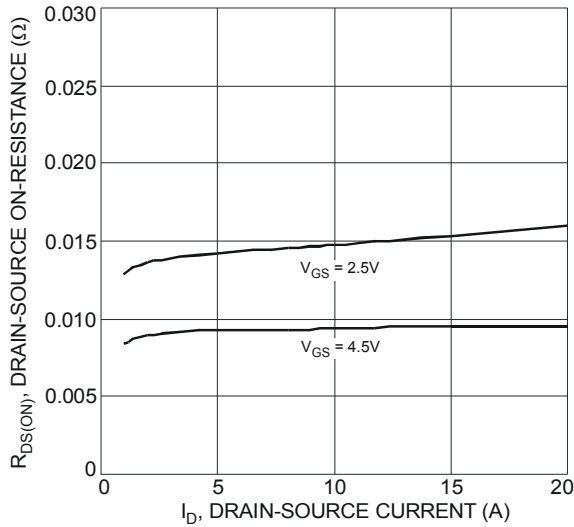


Fig. 3 Typical On-Resistance vs. Drain Current and Gate Voltage

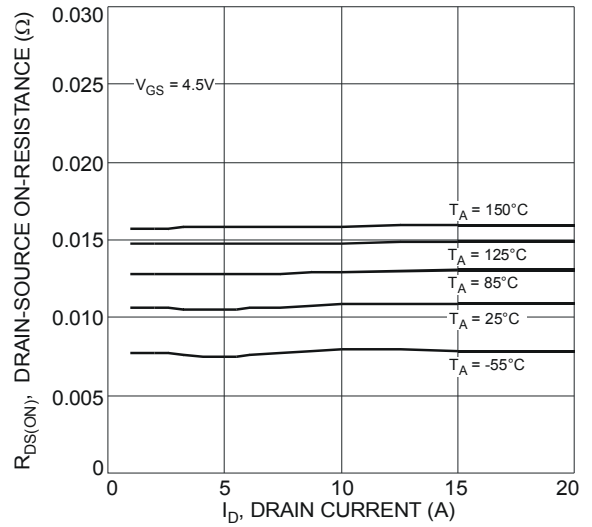


Fig. 4 Typical On-Resistance vs. Drain Current and Temperature

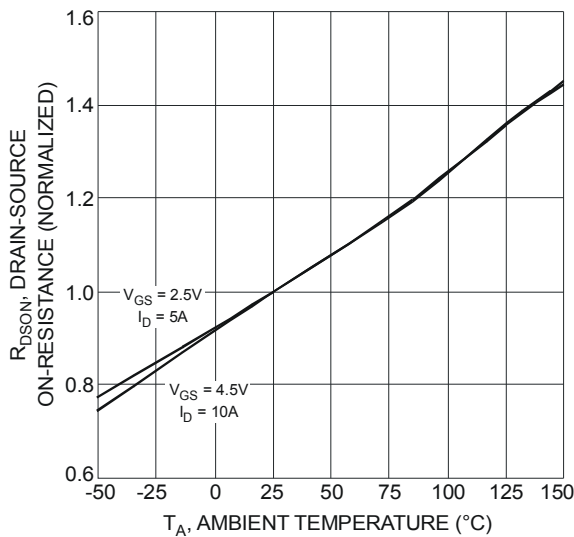


Fig. 5 On-Resistance Variation with Temperature

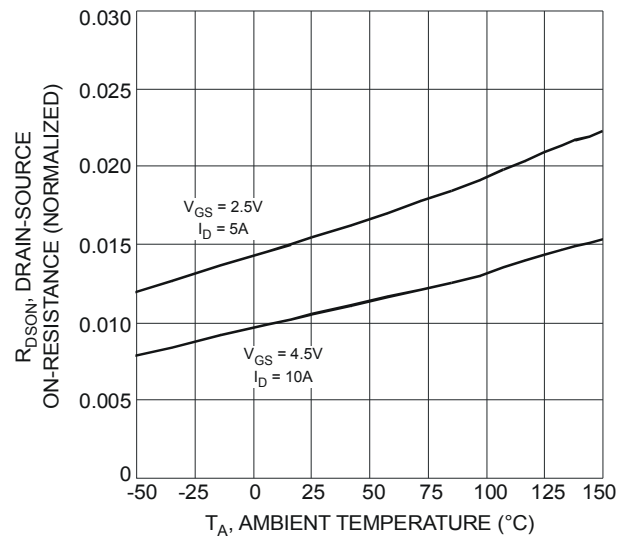


Fig. 6 On-Resistance Variation with Temperature

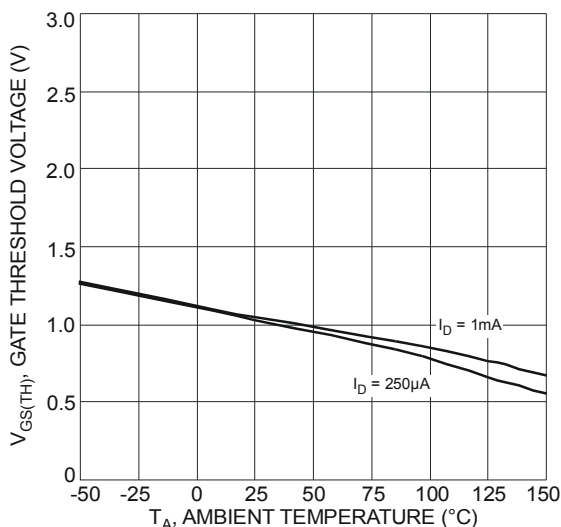


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

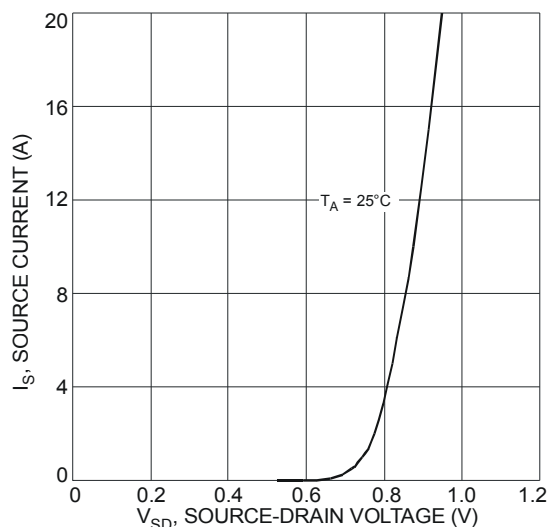


Fig. 8 Diode Forward Voltage vs. Current

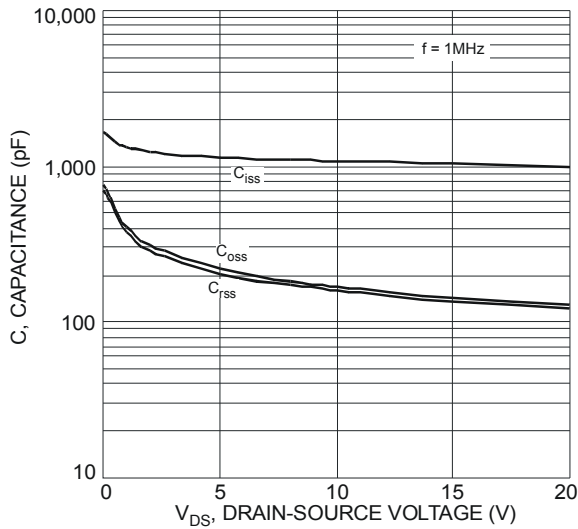


Fig. 9 Typical Total Capacitance

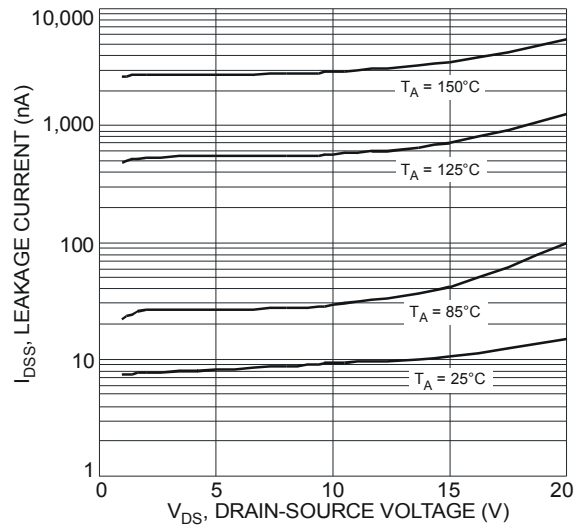


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage

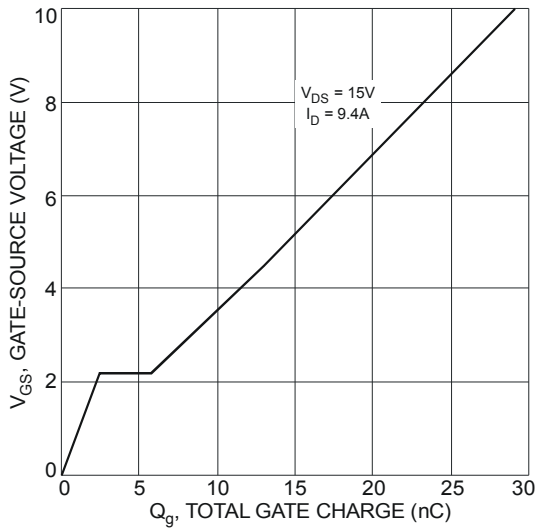
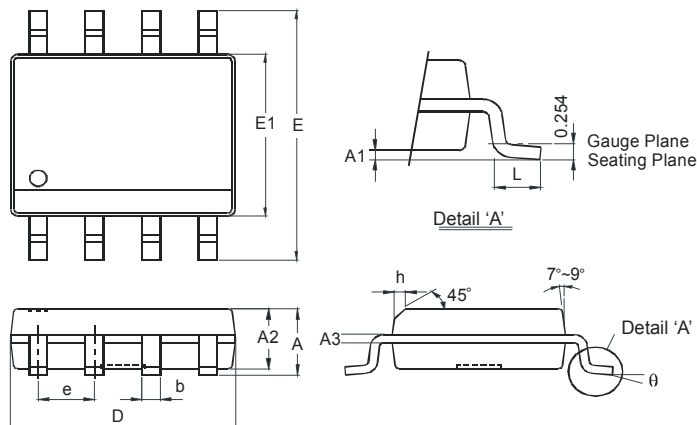


Fig. 11 Gate-Charge Characteristics

Package Outline Dimensions

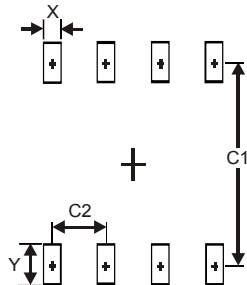
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SO-8		
Dim	Min	Max
A	-	1.75
A1	0.10	0.20
A2	1.30	1.50
A3	0.15	0.25
b	0.3	0.5
D	4.85	4.95
E	5.90	6.10
E1	3.85	3.95
e	1.27 Typ	
h	-	0.35
L	0.62	0.82
θ	0°	8°
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
X	0.60
Y	1.55
C1	5.4
C2	1.27

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